TOSHIBA Photocoupler GaAs Ired & Photo-Transistor

# TLP626, TLP626-2, TLP626-4

#### Programmable Controllers AC / DC-Input Module Telecommunication

The TOSHIBA TLP626, -2 and -4 consist of gallium arsenide infrared emitting diodes connected in inverse parallel, optically coupled to a photo–transistor.

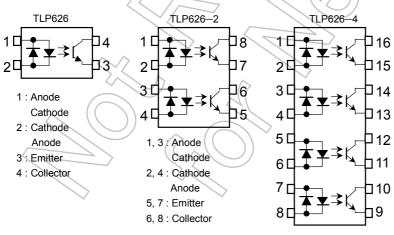
The TLP626–2 offers two isolated channels in an eight lead plastic DIP, while the TLP626–4 provides four isolated channels in a sixteen plastic DIP

- Collector-emitter voltage: 55V (min)
- Current transfer ratio

	Curre	(7)		
Classification	Ta =	25°C	Ta = -25~75°C	Marking of
	$I_F = \pm 1 \text{mA}$ $V_{CE} = 0.5 \text{V}$	$I_F = \pm 0.5 \text{mA}$ $V_{CE} = 1.5 \text{V}$	I <sub>F</sub> = ±1mA V <sub>CE</sub> = 0.5V	Classification
Rank BV	200%	100%	100%	BV
Standard	100%	50%	50%	BV, blank

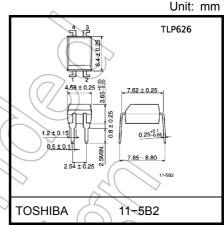
- Isolation voltage: 5000V<sub>rms</sub> (min)
- UL recognized: UL1577, file no.E67349
- BSI approved: BS EN60065: 2002 certificate no.7426
   BS EN60950-1: 2002 certificate no.7427
- Note: Application type name for certification test, please use standard product type name, i.e. TLP626(BV): TLP626

## Pin Configuration (top view)

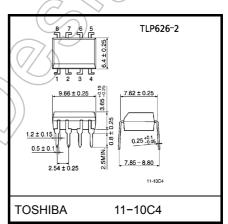


1, 3, 5, 7 : Anode, Cathode 2, 4, 6, 8 : Cathode, Anode 9, 11, 13, 15 : Emitter

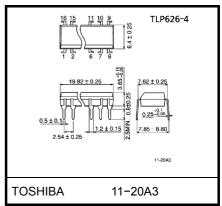
10, 12, 14, 16 : Collector



Weight: 0,26 g (typ.)



Weight: 0.54 g (typ.)



Weight: 1.1 g (typ.)

Start of commercial production 1984/04



#### Absolute Maximum Ratings (Ta = 25°C)

	Characteristic		Rati		
	Characteristic	Symbol	TLP626	TLP626-2 TLP626-4	Unit
	Forward current	lF	60	50	mA
	Forward current derating	ΔI <sub>F</sub> / °C	–0.7 (Ta ≥ 39°C)	–0.5 (Ta ≥ 39°C)	mA / °C
Ω	Pulse forward current	IFP	1 (100µs pul	se,100pps)	Α
LED	Power dissipation (1 circuit)	PD	100	70	mW
	Power dissipation derating (Ta ≥ 25°C, 1 circuit)	ΔP <sub>D</sub> / °C	_1.0	-0.7	mW / °C
	Junction temperature	Tj	12	5)	°C
	Collector-emitter voltage	V <sub>CEO</sub>	55		V
	Emitter–collector voltage	V <sub>ECO</sub>	7		V
ctor	Collector current	I <sub>C</sub>	50		mA
Detector	Collector power dissipation (1 circuit)	PC	150	100	mW
	Collector power dissipation derating (Ta ≥ 25°C, 1 circuit)	ΔP <sub>C</sub> /°C	-1.5 🔷	10	mW / °C
	Junction temperature	Tj	12	5	°C
Sto	rage temperature range	T <sub>stg</sub>	-55 to 125		°C
Оре	erating temperature range	Popr	-55 to 100		°C
Lea	Lead soldering temperature		260 (10s)		°C
Tot	Total package power dissipation (1 circuit)		250	150	mW
Tot	al package power dissipation derating (Ta ≥ 25°C, 1 circuit)	ΔP <sub>T</sub> /°C	-2.5	-1.5	mW / °C
Isol	ation voltage (Note 1)	BVS	5000 (AC, 1minu	ute, R.H.≤60%)	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 1) Device considered a two terminal: LED side pins shorted together, and detector side pins shorted together.

#### **Recommended Operating Conditions**

Characteristic	Symbol	Min	Тур.	Max	Unit
Supply voltage	V <sub>C</sub> C	_	5	24	V
Forward current	I <sub>F(RMS)</sub>	-	1.6	20	mA
Collector current	\\ \lc	_	1	10	mA
Operating temperature	T <sub>opr</sub>	-25	_	75	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

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#### **Individual Electrical Characteristics (Ta = 25°C)**

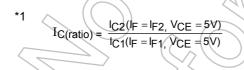
	Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	V <sub>F</sub>	I <sub>F</sub> = ±10mA	1.0	1.15	1.3	V
LED	Reverse current	l <sub>F</sub>	V <sub>F</sub> = ±0.7V	_	2.5	20	μΑ
	Capacitance	C <sub>T</sub>	V = 0, f = 1MHz	_ <	60	-	pF
	Collector–emitter breakdown voltage	V <sub>(BR)CEO</sub>	I <sub>C</sub> = 0.5mA	55			V
ō	Emitter–collector breakdown voltage	V <sub>(BR)ECO</sub>	I <sub>E</sub> = 0.1mA	7		1	V
Detector	Collector dark current	lana	V <sub>CE</sub> = 24V	6	10	100	nA
ă	Collector dark current	ICEO	V <sub>CE</sub> = 24V, Ta = 85°C		) 2	50	μΑ
	Capacitance collector to emitter	C <sub>CE</sub>	V=0, f=1MHz	1	12	_	pF

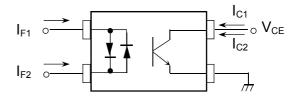
## **Coupled Electrical Characteristics (Ta = 25°C)**

		( )			$\sim$	
Characteristic	Symbol	Test Condition	Min	Тур	Max	Unit
Current transfer ratio	I <sub>C</sub> / I <sub>F</sub>	$I_F = \pm 1$ mA, $V_{CE} = 0.5$ V rank BV	100	7	1200 1200	%
Low input CTR	I <sub>C</sub> / I <sub>F</sub> (low)	$I_F = \pm 0.5$ mA, $V_{CE} = 1.5$ V rank BV	50	2	<sup>7</sup> –	%
Collector–emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = 0.5$ mA, $I_F = \pm 1$ mA $I_C = 1$ mA, $I_F = \pm 1$ mA rank BV	\ <u>-</u>	0.2 —	0.4 — 0.4	٧
Off-state collector current	I <sub>C</sub> (off)	V <sub>F</sub> = ±0.7V, V <sub>CE</sub> = 24V	//-	1	10	μΑ
CTR symmetry *1	I <sub>C</sub> (ratio)	$I_{C}(I_{F} = -1mA) / I_{C}(I_{F} = 1mA)$	0.5	_	2	_

# Coupled Electrical Characteristics ( $Ta = -25 \sim 75^{\circ}C$ )

	$\gamma$ / $\wedge$					
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Current transfer ratio	7 la/l=	$I_F = 1 \text{mA}, V_{CE} = 0.5 \text{V}$	50	-	1	%
Current transfer fatto	Ic/I <sub>F</sub>	rank BV	100	١		70
Low input CTR	I <sub>C</sub> / I <sub>F</sub> (low)	I <sub>F</sub> = 0.5mA, V <sub>CE</sub> = 1.5V	_	50	1	%
Low input one	IC / IF(IOW)	rank BV	_	100		/0







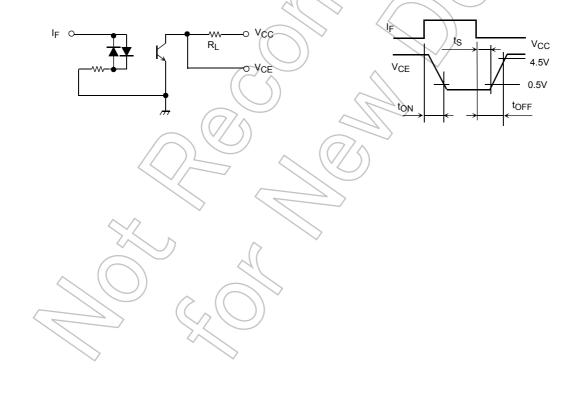
## Isolation Characteristics (Ta = 25°C)

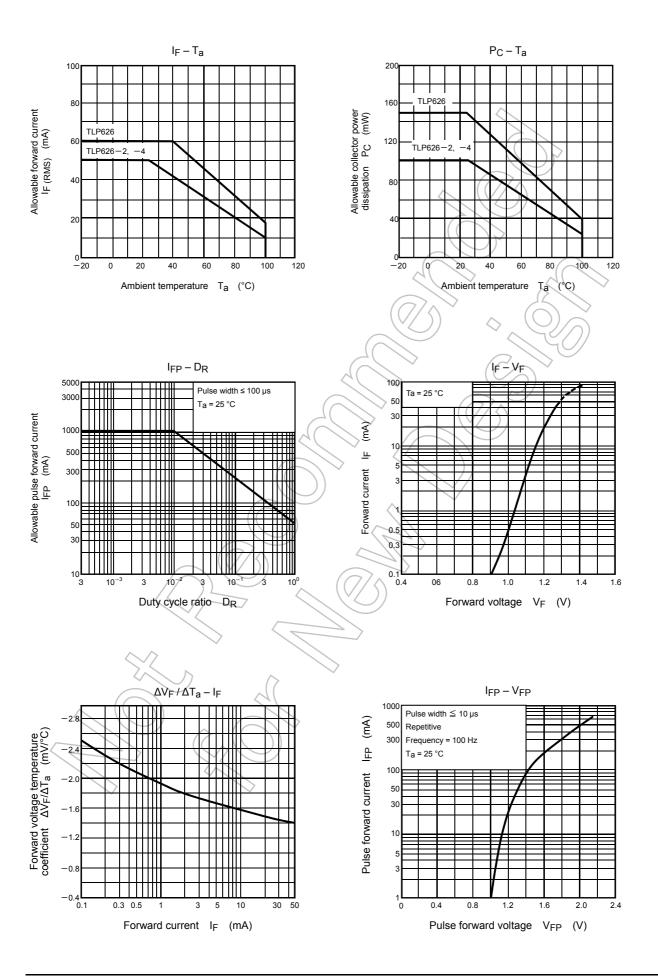
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	CS	V <sub>S</sub> = 0, f = 1MHz	_	0.8	_	pF
Isolation resistance	R <sub>S</sub>	V <sub>S</sub> = 500V	5×10 <sup>10</sup>	10 <sup>14</sup>	_	Ω
		AC, 1 minute	5000	/-	_	Vrma
Isolation voltage	$BV_S$	AC, 1 second, in oil	_	10000	_	Vrms
		DC, 1 minute, in oil	_	10000	)~-	Vdc

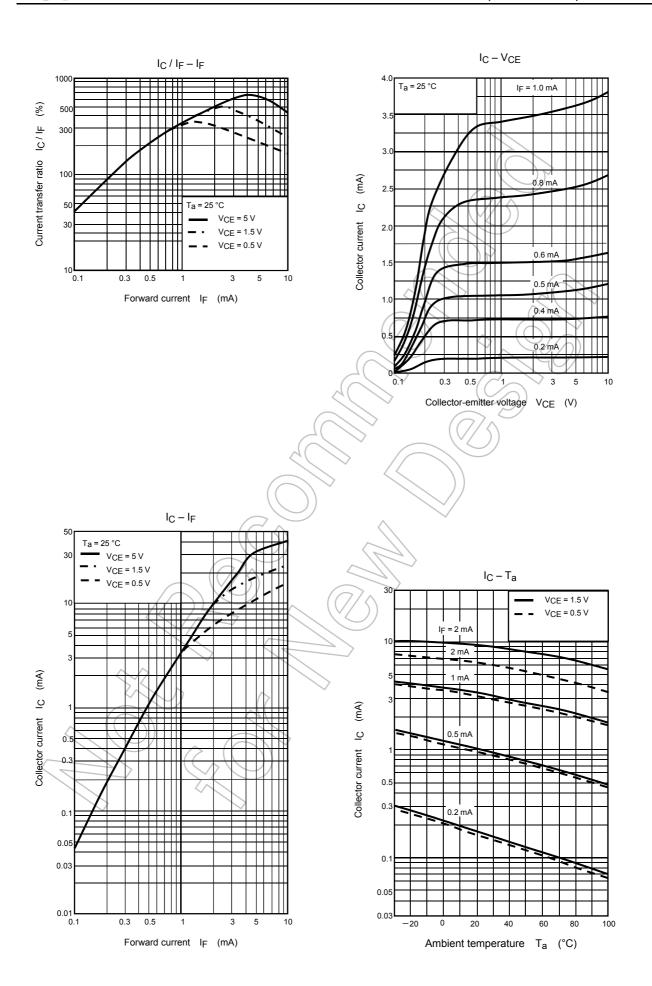
## **Switching Characteristics (Ta = 25°C)**

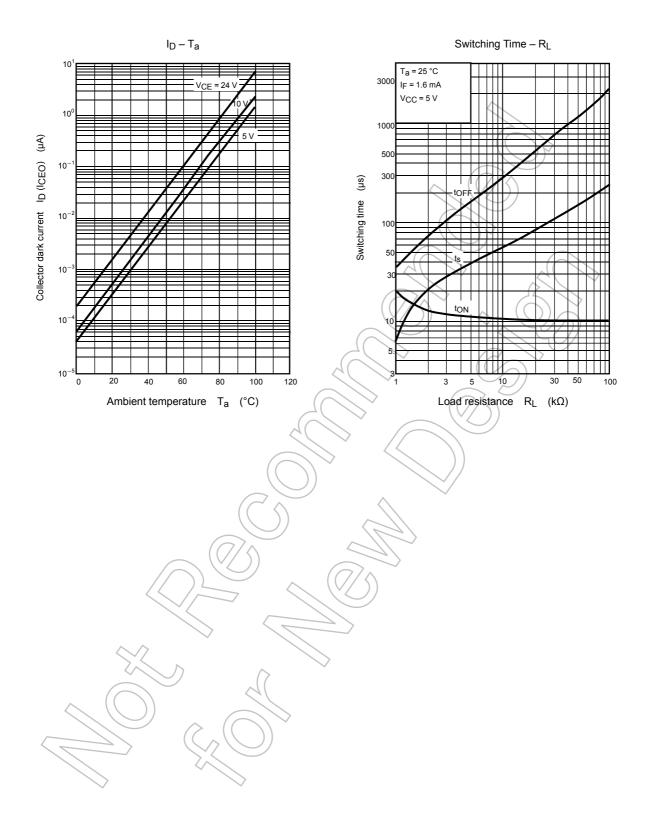
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Rise time	t <sub>r</sub>		)_	8		/
Fall time	t <sub>f</sub>	$V_{CC} = 10V$ , $I_C = 2mA$ $R_L = 100\Omega$	_	8 _	77	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\
Turn-on time	t <sub>on</sub>		· _	10	/-	μs
Turn-off time	t <sub>off</sub>		_<	8		)
Turn-on time	ton		-	19	((	
Storage time	t <sub>s</sub>	$R_L = 4.7 k\Omega \text{ (Fig.1)}$ $V_{CC} = 5 \text{ V, I}_F = \pm 1.6 \text{mA}$	-((	50	<sup>7</sup> –	μs
Turn-off time	toff	33		300	_	

Fig. 1 Switching operating conditions









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